FEATURES

- -55°C to +125°C operation
- 50 dB min. attenuation at 500 kHz differential mode
- 45 dB min. attenuation at 5MHz common mode
- Compliant to MIL-STD-461C, CE03
- Compatible with MIL-STD-704A through E

EMI INPUT FILTER 28 VOLT INPUT SURFACE MOUNT



FMGA EMI FILTER 0.8 AMP

MODEL

FMGA-461

0.8 amp

Size (max.): 1.010 x 0.880 x 0.250 inches (25.65 x 22.35 x 6.35 mm)

Shown with "Gull Wing" lead option, also available with straight leads. See Section B8, case B, for dimensions and options.

Weight: 10.3 grams typical, 11.5 grams maximum

Screening: Standard or ES. See Section C2 for screening options, see

Section A5 for ordering information.

DESCRIPTION

Interpoint's surface mount FMGA-461TM EMI filter has been designed to work with Interpoint's surface mount MGA and MGH Series DC/DC converters. Multiple MGA or MGH Series converters can be operated from a single FMGA filter provided the total power line current does not exceed the filter's maximum rating. The FMGA filter will reduce the converter's power line reflected ripple current to within the limit of MIL-STD-461C, Method CE03 as shown in Figures 4 through 7. The filter uses only ceramic capacitors for reliable high-temperature operation.

CONNECTION AND OPERATION

Where more than one pin has the same designation (e.g. pins 7, 8, and 9 are Positive Output), all of those pins must be connected for output performance to meet the specifications.

The MGA Series has an internal 2 μF capacitor its input terminals and the MGH Series has an internal 0.47 μF capacitor across its input power terminals. When the MGA or MGH converters are used with the FMGA filter, this capacitor becomes part of the filter and forms its final LC output section. When 2 or 3 MGA or MGH converters are used with a single filter, this capacitor becomes larger, improving the rejection versus frequency.

TRANSIENT DAMPING

The optional damping circuit shown in Figure 2 will prevent filter overshoot caused by 80 V transients with rise times of less than 200

microseconds. The damping circuit can be used with a 1.50 Ω resistor in series with the filter's positive input where the additional line loss can be tolerated. For transients with rise times of greater than 200 microseconds, there is no overshoot and the damping circuit is not required.

SURFACE MOUNT PACKAGE

The FMGA EMI filter can be surface mounted with pick-and-place equipment or manually. It is recommended that the case be attached with flexible epoxy adhesive or silicone which is thermally conductive (>1 watt /meter/°K).

Internal components are soldered with SN96 (melting temperature 221°C) to prevent damage during reflow. Maximum reflow temperature for surface mounting the FMGA filter is 220°C for a maximum of 30 seconds. SN60, 62, or 63 are the recommended types of solder. Hand soldering should not exceed 300°C for 10 seconds per pin.

The hermetically sealed metal cases are available in two different lead configurations. See Section B8, case B.

LAYOUT REQUIREMENTS

The case of the filter must be connected to the case of the converter through a low impedance connection to minimize EMI.



interpoint

A CRANE CO. COMPANY





FMGA EMI FILTER **0.8 AMP**

EMI INPUT FILTERS

ABSOLUTE MAXIMUM RATINGS

Input Voltage

- 0 to 40 VDC continuous
- 80 V for 100 ms transient

Lead Soldering Temperature (10 sec per lead)

• 300°C

Storage Temperature Range (Case)

• -65°C to +150°C

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range

- 16 to 40 VDC continuous
- Case Operating Temperature (Tc)

 -55°C to +125°C full power

Derating Input and Output Current

• Derate linearly from 100% at 100°C to 0.60 Amps at 125°C case. Above 125°C derate to 0%

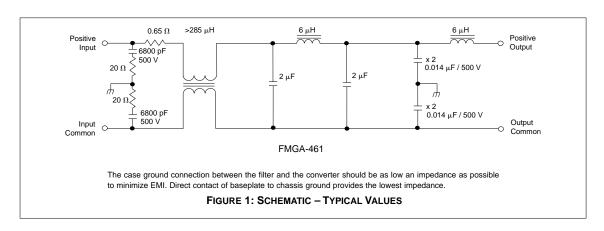
TYPICAL CHARACTERISTICS

Capacitance

- 0.045 µF max, any pin to case Isolation
 - 100 megohm minimum at 500 V
 - Any pin to case, except case pin

Electrical Characteristics: 25°C Tc, nominal Vin, unless otherwise specified.

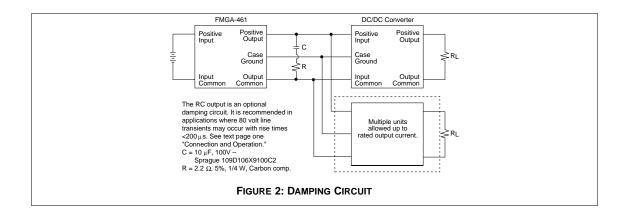
| | | FMGA-461 | | | |
|----------------------------------|----------------------------|--------------------------------------|-----|------|-------|
| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| INPUT VOLTAGE | CONTINUOUS | 0 | 28 | 40 | VDC |
| | TRANSIENT 100 ms | _ | _ | 80 | V |
| INPUT CURRENT | | _ | _ | 0.80 | A |
| DIFFERENTIAL MODE | 500 kHz | 50 | _ | _ | - dB |
| NOISE REJECTION | 5 MHz | 45 | _ | _ | UB UB |
| COMMON MODE | | | | | |
| NOISE REJECTION | 2 MHz - 50 MHz | 40 | _ | _ | dB |
| DC RESISTANCE (R _{DC}) | TC = 25°C | _ | _ | 1.50 | Ω |
| OUTPUT VOLTAGE | STEADY STATE | $V_{OUT} = V_{IN} - I_{IN} (R_{DC})$ | | | VDC |
| OUTPUT CURRENT | STEADY STATE (<100°C CASE) | _ | _ | 0.80 | A |
| INTERNAL POWER | | | | | |
| DISSIPATION | MAXIMUM CURRENT | _ | _ | 1.37 | l w |

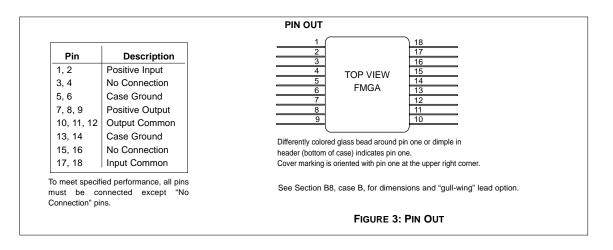




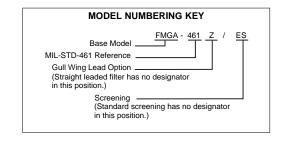
EMI INPUT FILTERS

FMGA EMI FILTER 0.8 AMP





| DSCC NUMBER | | | | | |
|--|---------------------------------|--|--|--|--|
| DSCC DRAWING (5915) | FMGA-461 FILTER SIMILAR PART | | | | |
| IN PROCESS | FMGA-461/883 | | | | |
| For exact specifications for a DSCC product, refer to the DSCC drawing. Call you Interpoint representative for status on the FMGA DSCC models. See Section A3, "SMD/DSCC Lists", for more information. | | | | | |

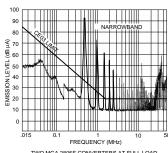




FMGA EMI FILTER 0.8 AMP

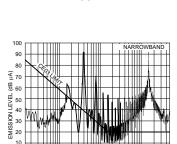
EMI INPUT FILTERS

Typical Performance Curves: 25°C Tc , nominal Vin, unless otherwise specified.



TWO MGA 2805S CONVERTERS AT FULL LOAD WITHOUT FILTERING TYPICAL POWER LINE SPECTRAL NOISE CURRENT

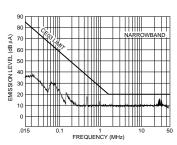
FIGURE 4



FREQUENCY (MHz)

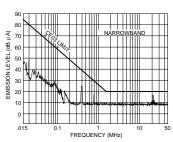
TWO MGH 2805S CONVERTERS AT FULL LOAD
WITHOUT FILTERING
TYPICAL POWER LINE SPECTRAL NOISE CURRENT

FIGURE 6



TWO MGA 2805S CONVERTERS AT FULL LOAD WITH FMGA-461 POWER LINE FILTERING TYPICAL POWER LINE SPECTRAL NOISE CURRENT

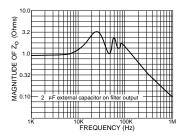
FIGURE 5



TWO MGH 2805S CONVERTERS AT FULL LOAD WITH FMGA-461 POWER LINE FILTERING TYPICAL POWER LINE SPECTRAL NOISE CURRENT

FIGURE 7

CRANE



Typical Output Impedance (Z) With Input Shorted

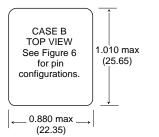
FIGURE 8

26221-001-DTS RevA DQ# 4011 FMGA-461 is a trademark of Interpoint. © Interpoint 1999





Differently colored glass bead around pin one or dimple in header (bottom or side of case) indicates pin one.



Cover marking is oriented with pin one at the upper right corner.

Materials

Kovar/Nickel/Gold Header Kovar/Nickel Cover Pins Kovar/Nickel/Gold, matched glass seal

Case dimensions in inches (mm)

Tolerance ± 0.005 (0.13) for three decimal places

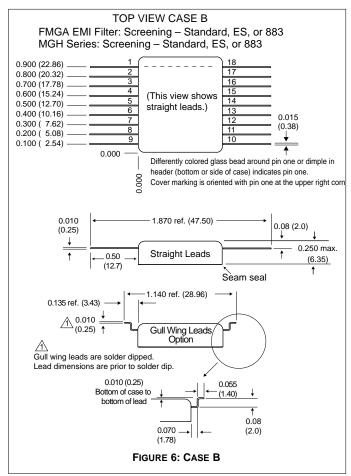
±0.01 (0.3) for two decimal places unless otherwise specified

CAUTION

Maximum reflow temperature is 220°C for a maximum of 30 seconds. SN60, SN62, or SN63 are the recommended types of solder. See below for Solder Mask instructions.

Hand soldering should not exceed 300°C for 10 seconds per pin.

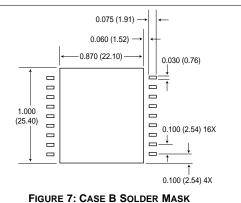
FIGURE 5: CASE B MAXIMUM DIMENSIONS



Solder Mask Notes

- 1. Pad dimensions are for the solder mask opening. Lead common to each other can be connected underneath as desired.
- 2. Ground pins should be connected to the center pad for improved grounding.
- 3. Center pad should not have a solder mask. Solder, copper, or Au/Ni plate are preferred over solder for adhesive attach.

 4. Solder coat to solder down converter.
- 5. If less rotation of case is desired, make the pad width 0.020inches (0.51 mm). Pad length can be extended 0.010 inches (0.25 mm) towards the case body and as-desired dimension away from the case body.
- 6. Do not exceed 220°C as measured on the body of the converter (top or bottom).
- 7. Attach the body of the case to the board with a thermally conductive adhesive or SN60, 62, or 63 solder. The adhesive can be electrically conductive as well. It can be applied as an underfill post solder or dispensed and cured prior or during solder.



Note: Although every effort has been made to render the case drawings at actual size, variations in the printing process may cause some distortion. Please refer to the numerical dimensions for accuracy.



QA SCREENING 125°C PRODUCTS

125°C PRODUCTS

| TEST (125°C Products) | STANDARD | /ES | /883 (Class H)* | |
|--|----------|---------|-----------------|--|
| | | | | |
| PRE-CAP INSPECTION | | | | |
| Method 2017, 2032 | yes | yes | yes | |
| TEMPERATURE CYCLE (10 times) | | | | |
| Method 1010, Cond. C, -65°C to 150°C | no | no | yes | |
| Method 1010, Cond. B, -55°C to 125°C | no | yes | no | |
| CONSTANT ACCELERATION | | | | |
| Method 2001, 3000 g | no | no | yes | |
| Method 2001, 500 g | no | yes | no | |
| BURN-IN | | | | |
| Method 1015, 160 hours at 125°C | no | no | yes | |
| 96 hours at 125°C case (typical) | no | yes | no | |
| | | , , , , | | |
| FINAL ELECTRICAL TEST MIL-PRF-38534, Group A | | | | |
| Subgroups 1 through 6: -55°C, +25°C, +125°C | no | no | yes | |
| Subgroups 1 and 4: +25°C case | yes | yes | no | |
| HERMETICITY TESTING | | | | |
| Fine Leak, Method 1014, Cond. A | no | yes | yes | |
| Gross Leak, Method 1014, Cond. C | no | yes | yes | |
| Gross Leak, Dip (1 x 10 ⁻³) | yes | no | no | |
| | | | | |
| FINAL VISUAL INSPECTION | | | | |
| Method 2009 | yes | yes | yes | |

Test methods are referenced to MIL-STD-883 as determined by MIL-PRF-38534.

Applies to the following products

| MOR Series | MHD Series | MGH Series | FMGA EMI Filter |
|--------------|--------------|----------------------|-----------------|
| MFLHP Series | MHV Series | MCH Series | FMSA EMI Filter |
| MFL Series | MHF+ Series | FM-704A EMI Filter | HUM Modules** |
| MHP Series | MHF Series** | FMD**/FME EMI Filter | LCM Modules** |
| MTR Series | MGA Series | FMC EMI Filter | LIM Modules |
| MQO Series** | MSA Series | FMH EMI Filter | |

^{**}MFLHP Series, MQO Series, MHF Series, FMD EMI Filters, Hum Modules, and LCM Modules do not offer '883" screening.



^{*883} products are built with element evaluated components and are 100% tested and guaranteed over the full military temperature range of –55°C to +125°C.